RULE 63 (37 C.F.R. 1.63) DECLARATION AND POWER OF ATTORNEY FOR PATENT APPLICATION IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

As a below named inventor, I hereby declare that my residence, post office address and citizenship are as stated below next to my name, and I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled: **ENHANCED CHIP SCALE PACKAGE FOR WIRE BOND DIES**, the specification of which (check applicable box(es):

DIES , the specification of what [X] is attached hereto; [] was filed on	al application No. PCT/	as U.S. Application Serial No	and (if					
I hereby state that I have re the claims, as amended by a		contents of the above-identified spoove.	ecification, including					
accordance with 37 C.F.R. foreign application(s) for pat	 1.56(a). I hereby claim for ent or inventor's certificate lintor's certificate having a filin 	is material to the patentability o eign priority benefits under 35 U.S isted below and have also identifien ng date before that of the application this application:	S.C. 119/365 of any d below any foreign					
Application Number	Country	Day/Month/Year Filed						
I hereby claim the benefit under 35 U.S.C. 120/365 of all prior United States and PCT international applications listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in such prior application in the manner provided by the first paragraph of 35 U.S.C. 112, I acknowledge the duty to disclose material information as defined in 37 C.F.R. 1.56(a) which occurred between the filing date of the prior applications and the national or PCT international filing date of this application: Prior U.S./PCT Application(s):								
Application Serial No.		Status: patented, pending	g, abandoned					
information and belief are be that willful false statements a	lieved to be true, and furthe nd the like so made are puni s Code and that such willfi	knowledge are true and that all so that these statements were made shable by fine or imprisonment, or lul false statements may jeopardize	with the knowledge ooth, under §1001 of					
Number 24112 in the record	is of the United States Pate cation and to transact all bu	Coats & Bennett, P.L.L.C., as ideent and Trademark Office and as usiness in the Patent and Trademark L. Coats).	pdated from time to					
·	2411 PATENT TRADEMA	· -						
Inventor's Signature	July Land	Date 3/9/01						
Inventor's Name(typed) Yor	ig Kee	YeoYeo	Singapore					
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